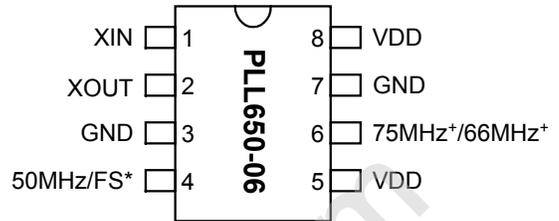


FEATURES

- Full CMOS output swing with 40-mA output drive capability, 25-mA output drive at TTL level.
- Advanced, low power, sub-micron CMOS processes.
- 25MHz fundamental crystal or clock input.
- One output fixed at 50MHz
- One selectable frequency output of 66.6 or 75MHz (with Double Drive Strength output).
- Zero PPM synthesis error in all clocks.
- Ideal for Network switches.
- 3.3V operation.
- Available in 8-Pin 150mil SOIC.

PIN CONFIGURATION



*: bi-directional pin + : double strength output

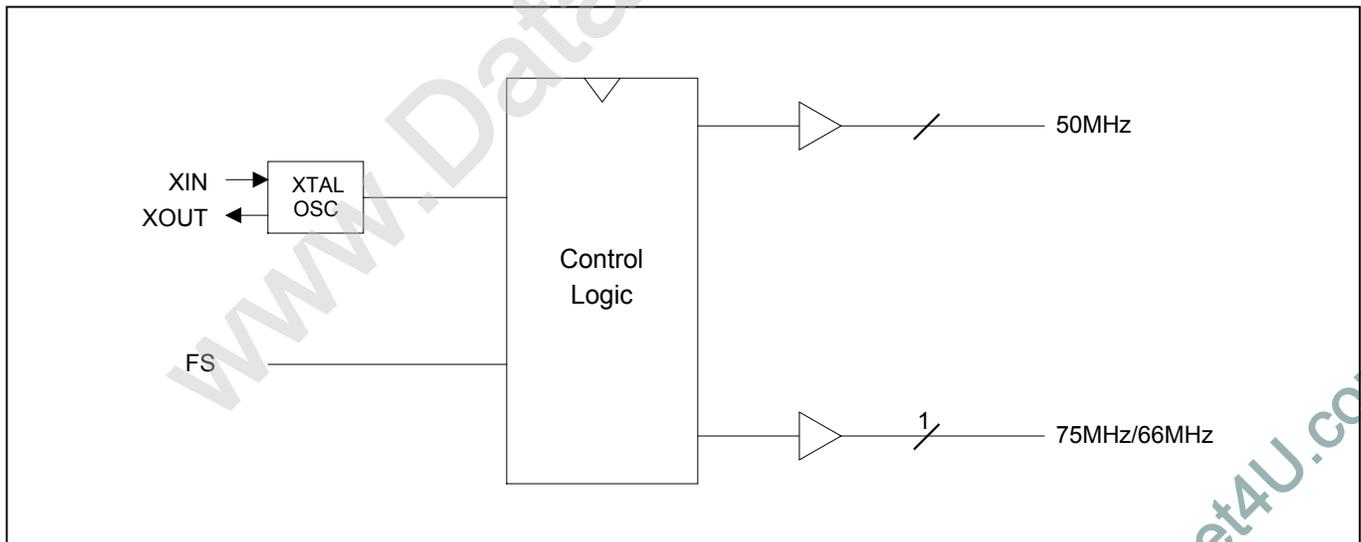
FREQUENCY TABLE

FS	Pin 6
0	75MHz
1	66.6MHz

DESCRIPTIONS

The PLL 650-06 is a low cost, low jitter, and high performance clock synthesizer. With PhaseLink's proprietary analog Phase Locked Loop techniques, the chip accepts 25.0 MHz crystal, and produces one 50MHz output clock and one selectable 75MHz or 66.6MHz output clock, making the chip ideal for networking applications.

BLOCK DIAGRAM



PIN DESCRIPTIONS

Name	Number	Type	Description
XIN	1	I	25MHz fundamental crystal input (20pF C _L parallel resonant). C _L have been integrated into the chip. No external C _L capacitor is required.
XOUT	2	I	Crystal connection pin.
50MHz/FS	4	B	50MHz outputs. This pin latches the FS input value at power-up. It has a 60kΩ internal pull up resistor.
75MHz / 66MHz	6	O	75MHz or 66.6MHz outputs with double drive strength. The output frequency is determined by the value of FS (see pin 4).
VDD	5, 8	P	3.3V power supply.
GND	3, 7	P	Ground.

FUNCTIONAL DESCRIPTION

Selectable spread spectrum and output frequencies

The PLL650-06 provides selectable output frequencies. Selection is made by connecting the selector pin to a logical “zero” or “one”, or by leaving it not connected (internal pull-up) according to the frequency selection table shown on page 1.

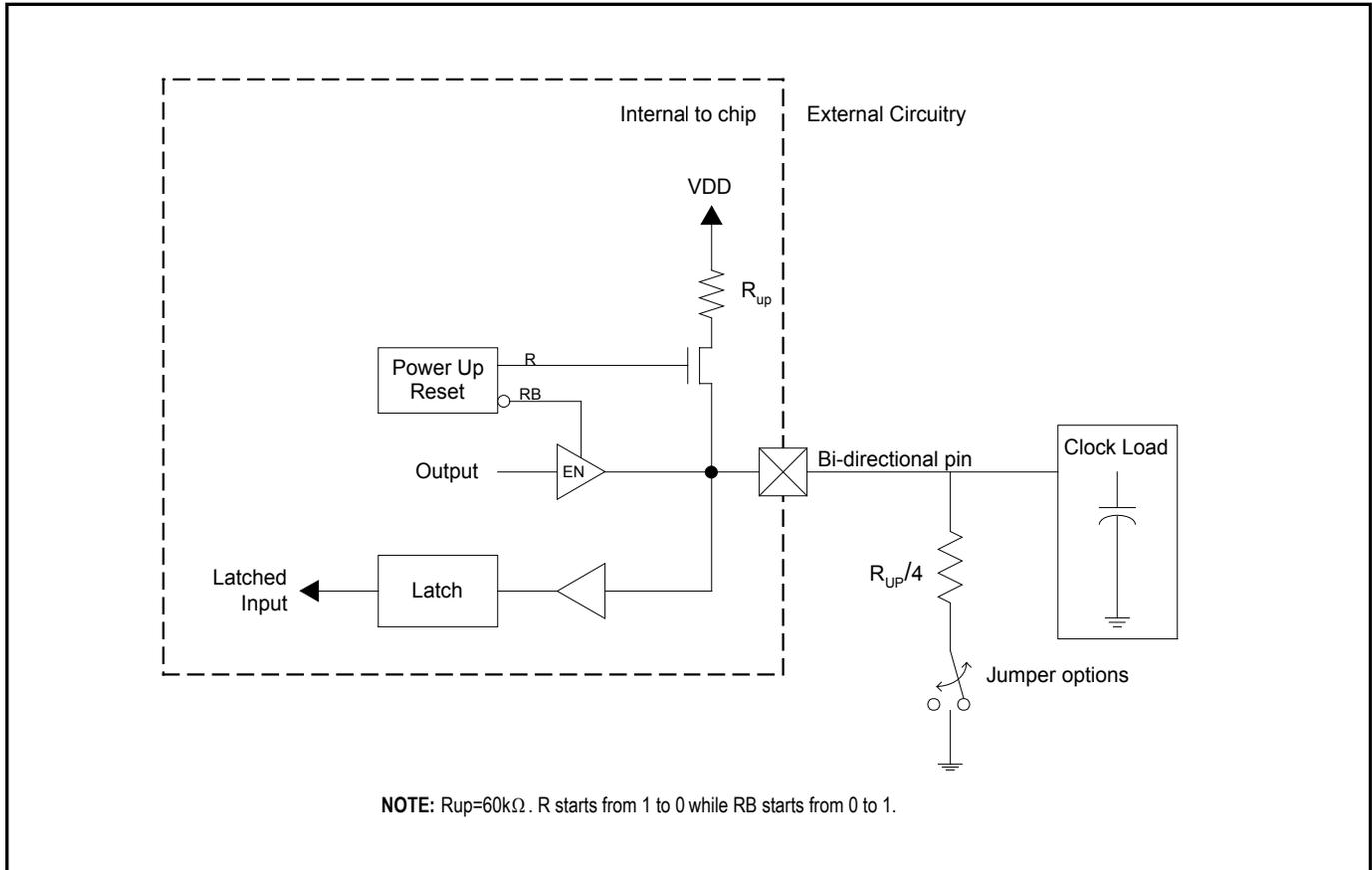
Pin 4 (FS) is a bi-directional pin used to select the output frequency of pin 6 (75MHz or 66.6MHz) according to the Frequency Selection Table on page 1. The description of how to connect this bi-directional pin follows in the next paragraph.

Connecting a bi-directional pin

A bi-directional pin serves as input upon power-up, and as output as soon as the inputs have been latched. The value of the input is latched-in upon power-up. Depending on the pin (see pin description), the input can be tri-level or a standard two-level. Unlike unidirectional pins, bi-directional pins cannot be connected directly to GND or VDD in order to set the input to “0” or “1”, since the pin also needs to serve as output. In the case of two level input pins, an internal pull-up resistor is present. This allows a default value to be set when no external pull down resistor is connected between the pin and GND (by definition, a tri-level input has a the default value of “M” (mid) if it is not connected). In order to connect a bi-directional pin to a non-default value, the input must be connected to GND or VDD through an external pull-down/pull-up resistor. **Note:** *when the output load presents a low impedance in comparison to the internal pull-up resistor, the internal pull-up resistor may not be sufficient to pull the input up to a logical “one”, and an external pull-up resistor may be required.*

For bi-directional inputs, the external loading resistor between the pin and GND has to be sufficiently small (compared to the internal pull-up resistor) so that the pin voltage be pulled below 0.8V (logical “zero”). In order to avoid loading effects when the pin serves as output, the value of the external pull-down resistor should however be kept as large as possible. In general, it is recommended to use an external resistor of around one sixth to one quarter of the internal pull-up resistor (see Application Diagram). **Note:** *when the output is used to drive a load presenting an small resistance between the output pin and VDD, this resistance is in essence connected in parallel to the internal pull-up resistor. In such a case, the external pull-down resistor may have to be dimensioned smaller to guarantee that the pin voltage will be low enough achieve the desired logical “zero”. This is particularly true when driving 74FXX TTL components.*

APPLICATION DIAGRAM



Electrical Specifications

1. Absolute Maximum Ratings

PARAMETERS	SYMBOL	MIN.	MAX.	UNITS
Supply Voltage Range	V_{CC}	-0.5	7	V
Input Voltage Range	V_I	-0.5	$V_{CC}+0.5$	V
Output Voltage Range	V_O	-0.5	$V_{CC}+0.5$	V
Soldering Temperature			260	$^{\circ}C$
Storage Temperature	T_S	-65	150	$^{\circ}C$
Ambient Operating Temperature		0	70	$^{\circ}C$

Exposure of the device under conditions beyond the limits specified by Maximum Ratings for extended periods may cause permanent damage to the device and affect product reliability. These conditions represent a stress rating only, and functional operations of the device at these or any other conditions above the operational limits noted in this specification is not implied.

2. AC Specification

PARAMETERS	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Frequency		10	25	27	MHz
Output Rise Time	0.8V to 2.0V with no load			1.5	ns
Output Fall Time	2.0V to 0.8V with no load			1.5	ns
Duty Cycle	At VDD/2	45	50	55	%
Max. Absolute Jitter	Short term		±150		ps
Max. Jitter, cycle to cycle				80	ps

3. DC Specification

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Operating Voltage	VDD		3.13		3.47	V
Input High Voltage	V _{IH}			VDD/2		V
Input Low Voltage	V _{IL}			VDD/2	VDD/2 - 1	V
Input High Voltage	V _{IH}	For all Tri-level input	VDD-0.5			V
Input Low Voltage	V _{IL}	For all Tri-level input			0.5	V
Input High Voltage	V _{IH}	For all normal input	2			V
Input Low Voltage	V _{IL}	For all normal input			0.8	V
Output High Voltage	V _{OH}	I _{OH} = -25mA	2.4			V
Output Low Voltage	V _{OL}	I _{OL} = 25mA			0.4	V
Output High Voltage At CMOS Level	V _{OH}	I _{OH} = -8mA	VDD-0.4			V
Operating Supply Current	I _{DD}	No Load		35		mA
Short-circuit Current	I _S			±100		mA
Nominal output current*	I _{out}	CMOS output level	35	40		mA
Nominal output current*	I _{out}	TTL output level	20	25		mA
Internal pull-up resistor	R _{up}	Pins 5,7		60		kΩ
Internal pull-up resistor	R _{up}	Pin 2		120		kΩ

*: Output strengths are doubled (i.e. min. CMOS level is 70mA, typ. CMOS level is 80mA) on pin 6 (output for 75MHz or 66.6MHz)

PACKAGE INFORMATION

8 PIN (dimensions in mm)

Symbol	Narrow SOIC		TSSOP	
	Min.	Max.	Min.	Max.
A	1.47	1.73	-	1.20
A1	0.10	0.25	0.05	0.15
B	0.33	0.51	0.19	0.30
C	0.19	0.25	0.09	0.20
D	4.80	4.95	2.90	3.10
E	3.80	4.00	4.30	4.50
H	5.80	6.20	6.20	6.60
L	0.38	1.27	0.45	0.75
e	1.27 BSC		0.65 BSC	

ORDERING INFORMATION

For part ordering, please contact our Sales Department:
47745 Fremont Blvd., Fremont, CA 94538, USA
Tel: (510) 492-0990 Fax: (510) 492-0991

PART NUMBER

The order number for this device is a combination of the following:
Device number, Package type and Operating temperature range

PLL650-06 S C

PART NUMBER _____

- _____ TEMPERATURE
- C=COMMERCIAL
- M=MILITARY
- I=INDUSTRIAL
- _____ PACKAGE TYPE
- S=SOIC

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